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# Controlled electrochemical and electroless deposition of noble metal nanoparticles on graphene<sup>†</sup>

Concha Bosch-Navarro,\*<sup>ab</sup> Jonathan P. Rourke<sup>b</sup> and Neil R. Wilson<sup>a</sup>

Electrodeposition of nanoparticles on graphene is described, providing a convenient approach for making graphene-nanoparticle composites as well as insight into the electrochemical activity of graphene. To avoid complications due to surface contamination, chemical vapour deposition grown graphene was used directly on its copper growth substrate. We identify and isolate two nanoparticle growth processes for both silver and palladium deposition: electroless deposition that appears to occur preferentially at defects and edges next to the underlying copper, and conventional electrodeposition that occurs uniformly across the graphene surface. We show that control over electrodeposited nanoparticle size and number density can be achieved through varying electrodeposition conditions. The resultant nanoparticles are homogeneously dispersed across the graphene surface, suggesting that here both edge-plane and basal-plane graphene sites are electroactive. These results demonstrate that, as with other carbon nanostructures, electrodeposition is a powerful and flexible tool for forming functional composites with graphene.

# Introduction

Metal nanoparticles (NPs) are of great interest because of their unique catalytic and sensing properties.<sup>1–3</sup> However, the prop-erties are tightly correlated with their size and morphology, and in addition, the dispersion of NPs onto appropriate substrates is a prerequisite for their implementation in practical devices.<sup>4</sup> Electrodeposition is a particularly interesting route to forming NPs structures, since by careful choice of the substrates and electrochemical parameters (i.e. applied potential, electrode-position time, analyte concentration), it is possible to control the size and morphology of the grown NPs.<sup>5–8</sup>

Carbon nanostructures such as carbon nanotubes (CNTs), high oriented pyrolytic graphite (HOPG) or graphene (Gr) have been widely explored as supports for the deposition and/or electrodeposition of NPs.<sup>5–16</sup> These three allotropes each have conjugated sp<sup>2</sup> carbon arranged in a hexagonal lattice, but each with a different geometry. Gr is a two dimensional material only a single layer thick, while HOPG is a 3D structure formed from regularly stacked Gr layers,<sup>17</sup> and CNTs are a one dimensional material which result from rolling up Gr sheets into closed cylinders.<sup>18</sup> The sp<sup>2</sup> structure of these materials confers on them electronic properties which are appropriate for the development of nanoscopic electrodes. In fact, the use of HOPG as an elec-trode for the deposition of metal NPs has been known for a long time. Of particular interest is the work by Penner's group on the mechanism of electrodeposition of a variety of metal NPs onto HOPG electrodes.<sup>7–9,19</sup> This work sets the scene for the utiliza-tion of other low dimensional carbon nanostructures (i.e. CNTs and Gr) as electrode materials for the electrodeposition of metal NPs. According to Penner et al. the growth of metal NPs onto HOPG is characterized by a rapid nucleation, followed by a progressive growth of NPs, which means that the growth is initially controlled by kinetics and then is diffusion limited. A similar trend has been observed by Macpherson's group when using CNTs as electrode material for the creation of metal nanowires.<sup>5,20-22</sup> In fact, Macpherson was able to control size, particle distribution and particle density by varying deposition time and applied potential,<sup>5</sup> similar to Penner's work on HOPG.9,19 To date, though, similar use of electrodeposition on Gr has been complicated by the several methodologies employed for its synthesis, which result in a variety of Gr with varying structural and chemical properties.<sup>23-25</sup>

Graphene can be obtained either following top-down (e.g. synthesis by reduction of graphene oxide)<sup>23,26–28</sup> or bottom-up methodologies (e.g. chemical vapour deposition of Gr).<sup>24,29,30</sup> The synthesis of Gr from the reduction of graphene oxide provides bulk quantities of a highly defective Gr material, usually referred to as reduced graphene oxide (rGO). Although electrodeposition has been employed to further modify rGO,<sup>31–33</sup> its intrinsic defects complicate the study of the fundamentals of

<sup>&</sup>lt;sup>a</sup>Department of Physics, University of Warwick, Coventry, CV4 7AL, UK. E-mail: concha.bosch.navarro@gmail.com

<sup>&</sup>lt;sup>b</sup>Department of Chemistry, University of Warwick, Coventry, CV4 7AL, UK

<sup>&</sup>lt;sup>†</sup> Electronic supplementary information (ESI) available: Additional SEM images, Raman analysis, additional electrochemical gures and XPS.

electrodeposition on graphene. Chemical vapour deposition (CVD), on the other hand, is a promising route to the formation of large area, high quality graphene. Gr is formed by CVD through the decomposition of a carbon feedstock over a metallic substrate, typically nickel or copper, at high temperature. The use of copper substrates, rather than nickel, has proven to be more effective in achieving monolayer Gr of large grain size. As a result, the properties of monolayer CVD-Gr on copper are comparable to those of mechanically exfoliated graphene.<sup>29</sup> However, the use of CVD-Gr grown on copper for electrochemical investigations has been hampered by the reactivity of copper itself, and the need to transfer Gr to an insulating substrate as a step prior to any electrochemical process.<sup>34–42</sup> The transferring process typically involves the use of polymer layers and metal etchants that lead to surface contaminants on the lattice of graphene.<sup>41,43</sup> Those contami-nants play a major role in the nal electrochemical behaviour and thus,<sup>40,44-46</sup> are undesirable for such studies. We have recently shown how electrochemical experiments can be directly made on CVD-Gr on copper, making quick cheap and reproducible graphene electrodes.<sup>47</sup> In this paper we extend this approach and demonstrate for the rst time how metal NPs can be grown directly on CVD-Gr under electrochemical control; we isolate electroless and electrodeposition processes and show that the electrodeposition proceeds with a similar mechanism to that previously observed on HOPG and CNT, opening the way to using established approaches for the controlled electro-chemical modi cation of graphene.

# Experimental methods

### Low-pressure CVD of graphene on copper

Gr was grown on copper foil using a low-pressure CVD system as described previously.<sup>48</sup> In brief, copper foil substrates (99.5% purity, 0.025 mm thick, Alfa Aesar product number 13382) were cleaned by electrochemical polishing and washing, following the procedure described by Miseikis et al.<sup>49</sup> Using a 1 inch tube furnace pumped to low pressure by a turbomolecular pump, the foil was heated to 1000 C and annealed for 20 minutes prior to growth. A hydrogen ow was maintained throughout the process, with methane introduced for the growth stage. The standard growth conditions used were 10 standard cubic cen-timetres (sccm) of hydrogen, with 2.5 sccm of methane and a growth time of 20 minutes. For partial coverage samples the growth time was reduced to 10 minutes. A er cooling to room temperature, the Gr on copper samples were removed from the furnace and stored under ambient conditions before use.

#### Raman spectroscopy and scanning electron microscopy (SEM)

Raman spectra were recorded with a Renishaw InVia micro-Raman system using a 514 nm laser excitation, with a laser power of ca. 5 mW. A confocal microscope with 50 lens was used to record spectra at a spatial resolution of 2 mm. SEM characterization was performed on a ZEISS Supra 55-VP eld emission SEM, operated at 10 kV, using the inLens secondary electron detector. Raman and SEM analysis were performed on

the Gr on copper foils as grown. ImageJ<sup>50</sup> was used to analyse the SEM images (Fig. SI2<sup>+</sup>) and quantify the coverage of the samples and the size of the grown nanoparticles (see Fig. SI3<sup>+</sup>).

#### Electrochemical processes

BST8-stat instrument from MTI KJ group was used to record cyclic voltammograms (CVs). A three-electrode con guration was used, where CVD-Gr on copper was the working electrode. To achieve a constant surface area for the electrode, each sample was masked with a piece of 3M Model 470 Electroplater tape with a pre-cut 0.05 cm<sup>2</sup> hole. A GAMRY electrochemical cell (model PTC1 paint test cell) was clamped to the working elec-trode (see ESI1<sup>+</sup>). As reference electrode and counter electrode a GAMRY Ag/AgCl (in saturated KCl) and a Pt wire were used, respectively. For the electrodeposition process the system was set up in time base mode. In a typical electrodeposition exper-iment the potential was xed at 0.4 V and the time was set as desired. To avoid the electroless redox process between Ag<sup>+</sup> and copper, the cell was mounted and the potential was xed at 0.46 V prior to the addition of electrolyte. A er deposition, the electrodes were thoroughly rinsed with deionized water and dried under nitrogen before SEM analysis.

#### Solutions

All chemicals were used as received. Aqueous solutions were prepared using high purity water. For electrodeposition experiments, either silver nitrate or palladium nitrate in a supporting electrolyte of potassium nitrate were used (Sigma-Aldrich).

# Results and discussion

## Graphene on copper growth and characterization

Graphene was grown on copper foil by low pressure CVD, as described in the experimental section. SEM analysis shows that continuous monolayer graphene coverage is formed (ESI2†): the CVD-Gr surface coverage is measured to be >99%, of which >95% is monolayer (ESI3†). This is consistent across CVD-Gr samples grown under the same conditions. With shorter growth times (see Experimental), an incomplete lm is formed and isolated Gr islands can be seen, resulting in a lower coverage of the copper surface (SEM, ESI2†).

The quality of the grown Gr was assessed by Raman spectroscopy in situ on the copper substrate. Typical Raman spectra for this material show single peaks for the G and the 2D bands at ca. 1580 cm<sup>1</sup> and 2690 cm<sup>1</sup>, respectively,<sup>51</sup> with no apparent D peak (expected at 1350 cm<sup>1</sup>), as shown in ESI4.<sup>†</sup> Moreover, the sharpness of the G and the 2D bands, and the ratio between their intensities ( $I_{2D}/I_G$  4) con rm that the sample is mainly composed of high quality monolayer graphene.<sup>51</sup>

The as grown CVD-Gr was used without modi cation as a working electrode for electrodeposition of nanoparticles.

#### Electrodeposition of silver NPs

Most of the previous electrochemical studies on CVD-Gr have been performed a er transfer of the Gr monolayer to insulating



Fig. 1 Cyclic voltammogram at 0.1 V s  $^{1}$  for the reduction of 0.7 mM AgNO3 in 0.2 M KNO3 using CVD-Gr as working electrode, with electrode surface area 0.05 cm<sup>2</sup>. The spikes between 0.1 and 0.05 V are acquisition artefacts.

substrates (e.g. silicon oxide) in order to avoid interference from the underlying copper.<sup>34–42</sup> However, we have recently demon-strated that electrochemical studies can be performed directly on CVD-Gr on copper with careful choice of the analytes.<sup>47</sup> Thus, the use of KNO<sub>3</sub> as supporting analyte, instead of the more typical KCl, allows the use of CVD-Gr in a potential window situated between 1.2 V and 0.4 V without corrosion and interference. This potential window is sufficient for the study of Ag and Pd deposition as described below.

A typical cyclic voltammogram (CV) for Ag electrodeposition on to a fresh CVD-Gr electrode is shown in Fig. 1. The CV shows a peak in the cathodic current for the reduction of  $Ag^+$  to  $Ag^0$  at around 0.2 V vs. Ag/AgCl, with evidence of the stripping of silver ( $Ag^0$  to  $Ag^+$ ) in the reverse scan direction.

To study the morphology of the deposited nanoparticles, electrodeposition with a de ned potential over set time periods was used. For the results shown in Fig. 2, 3 and SI6,<sup>†</sup> the potential at the CVD-Gr electrode was stepped from 0 V to 0.4 V (vs. Ag/AgCl) for a period of 30 s, and then to an open circuit. On both the fully covered CVD-Gr (Fig. 2a) and partially covered

CVD-Gr (Fig. 2b) electrodes, two types of AgNP are immediately apparent. There are large, micrometre scale, AgNPs which on the partially covered CVD-Gr sample clearly preferentially nucleate and grow at the edges of the sheet. But for both the partially covered and fully covered samples, the graphene itself is covered with small (10 s of nm in diameter) nanoparticles which are not present on the copper surface. These two types of particles suggests that two types of process are occurring.

Copper itself is electrochemically active, with the standard redox couple of  $Cu^{2+}/Cu^{0}$  having a redox potential of 0.34 V. This means that copper metal can spontaneously reduce any other species that has a more positive redox potential: this includes  $Ag^+$  ( $E^0(Ag^+/Ag^0)$ ) 1/4 0.8 V). Therefore, Ag<sup>+</sup> in contact with copper should react spontaneously, forming Ag in an electroless process.<sup>32,52-54</sup> As a consequence a reduction peak very close to 0 V is observed in the CV obtained when using copper foil as working electrode (ESI5<sup>+</sup>). To study this electroless process, CVD-Gr samples were immersed for 2 s in a solution containing 0.7 mM AgNO3 in KNO3 0.2 M. Subsequent SEM analysis, as shown in Fig. SI7,<sup>+</sup> showed the large, micrometre scale, AgNPs predominantly at graphene sheet edges, but without the small AgNPs on the Gr surface. On partially covered CVD-Gr samples (Fig. SI7a and b<sup>+</sup>), the electroless deposition clearly preferen-tially occurs on the graphene next to exposed copper, as should be expected. For the fully covered CVD-Gr (Fig. SI7c and d<sup>+</sup>), electroless deposition seems to occur along lines (possibly grain boundaries) and at isolated points (perhaps pinholes in the graphene), suggesting that it identi es the defects in the graphene lm. Prolonged electroless deposition on fully covered CVD-Gr electrodes results in tearing of the graphene and exposure of the copper (Fig. SI7e and f<sup>+</sup>). However, further work would be required to de nitively link the electroless deposition sites to defects in graphene.

In order to con rm our hypothesis that the large particles are due to electroless deposition, we sought to suppress the elec-troless process. Taking into account the redox potentials  $(Cu^{2+}/Cu^0)^{1/4} = 0.34$  V,  $Ag^+/Ag^0 = 1/4 = 0.8$  V), the effective potential of the electroless redox reaction is 0.46 V ( $Cu^0 + 2Ag^+/Cu^{2+} + 2Ag^0$ ).



Fig. 2 SEM images of a(i–iii) full covered CVD-Gr and b(i–iii) partially covered CVD-Gr sample, after electrodeposition and electroless deposition of AgNPs (at three different magnifications). The SEM images were acquired after electrodeposition at 0.4 V for 30 s in 0.7 mM of AgNO<sub>3</sub> in 0.2 M KNO<sub>3</sub>.



Fig. 3 SEM images of a(i–iii) full covered CVD-Gr and b(i–iii) partially covered CVD-Gr sample at three different magnifications after electro-deposition of AgNPs, whilst avoiding the electroless process. To avoid the electroless process the applied potential was adjusted to 0.46 V, and the electrochemical cell was mounted before adding the AgNO<sub>3</sub>. The working solution consisted of 0.7 mM of AgNO<sub>3</sub> in 0.2 M KNO<sub>3</sub>.

Therefore, to avoid the electroless process a potential of 0.46 V should be applied during the whole process (i.e. before the Ag<sup>+</sup> comes into contact with the CVD-Gr electrode). With this aim, both fully covered CVD-Gr and a partially covered CVD-Gr had the potential stepped from 0 V to 0.46 V (vs. Ag/AgCl) before the addition of the AgNO3. Evidence of the suppression of the electroless process can be seen in the current-time transient curves (ESI8<sup>+</sup>) where, when the electroless process is not avoi-ded (ESI8<sup>+</sup>) dashed line) a current of 33 nA is measured at 0 s, whereas, when the electrochemical cell is set to 0.46 V prior to the addition of Ag<sup>+</sup> (ESI8,<sup>†</sup> solid line), the initial current is 0 A. In this second case, immediately a er adding AgNO3 two distinct behaviours over time are apparent: rst the current increases sharply to 70 nA (due to the start of the electrodepo-sition process) followed by a sharp decay in the current to 35 nA, and then a rapid increase up to 68 nA. This behaviour is consistent with a very rapid nucleation and growth of NPs, where the active area increases sharply. A erwards, the current decreases with time until a constant value of ca. 10 nA is ach-ieved. This can be attributed to the overlap of diffusion elds of neighbouring NPs,<sup>6</sup> as has previously been observed in the electrodeposition of metal NPs on HOPG electrodes.9,19,55

SEM analysis of the samples provides proof of the suppres-sion of the electroless process. As shown in Fig. 3, following the protocol described above, the big AgNPs are no longer observed but small AgNPs homogeneously and selectively decorate the Gr, with no nanoparticles visible on the copper substrate.

#### Control over particle size and particle density

The size and distribution of AgNPs depends on the electrodeposition parameters. As the phenomena of electroless and electrodeposition are in most regions independent of one another, a simple potential step process was used for further study of the electrodeposition process and the larger NPs formed from the electroless deposition were ignored. The dependence of the AgNPs on deposition time was studied by stepping the voltage from 0.0 to 0.4 V (vs. Ag/AgCl) for 1, 5, 10 and 30 s. In all cases, the solution contained 0.7 mM AgNO<sub>3</sub> in 0.2 M KNO3. The particle size and particle number density (number of nanoparticles per unit area, mm<sup>2</sup>) were analysed by SEM using image J so ware (ESI3<sup>†</sup>).<sup>50</sup> In Fig. 4b the mean particle size versus the electrodeposition time is plotted; the mean particle size of the AgNPs increases from 22.9 9.4 nm at 1 s, to 50.2 17 nm at 30 s, while the number of particles per unit area decreases with deposition time until it reaches a minimum (Fig. 4c). This suggests that neighbouring NPs merge as the deposition progresses. Moreover, the size distribution of AgNPs becomes broader with increasing time. This behaviour is consistent with that observed for the growth of metal NPs on HOPG, where deposition typically proceeds by an initial rapid nucleation stage immediately a er the voltage is applied (kinetic control), and therea er, a gradually growth of the NPs (diff usion control).<sup>19</sup>

The effect of the applied potential was studied by stepping the voltage from 0.0 V to 0.2 V, 0.4 V, 0.6 V and 0.8 V for 30 s, in a solution containing 0.7 mM AgNO<sub>3</sub> in 0.2 M KNO<sub>3</sub>. As expected from the cyclic voltammogram (Fig. 1) at 0.2 V the driving force is on the limit for starting the electrodeposition process. As a consequence, a high polydispersity of NPs is observed, showing a very low particle density (Fig. 5). For increasing potentials (> 0.4 V vs. Ag/AgCl), the size distribution becomes narrower, the mean particle diameter decreases and the number of particles per unit area increases (Fig. 5). This behaviour is similar to that previously observed for the depo-sition of metal NPs onto carbon nanotubes;<sup>5</sup> increased nucle-ation density at higher overpotentials then results in a decreased (overlapping) ux to each NP and hence smaller NP size.

Even at low overpotentials, the electrodeposition of AgNPs appears to be random and homogeneous across the whole of the Gr surface. There is no evidence for preferred deposition at wrinkles or other 'defect' sites, and it appears that the basal-plane Gr is electroactive, supporting what we and others have previously found,<sup>40,47,56</sup> but in contrast to other reports that have suggested that the basal-plane of Gr has negligible electro-chemical activity.<sup>36,57</sup>



Fig. 4 (a) SEM images and corresponding histogram analysis showing the particle size distribution of the AgNPs deposited at CVD-Gr electrodes during 1 s, 5 s, 10 s and 30 s. For all the cases, the solution contained 0.7 mM AgNO3 in 0.2 M KNO3 and the potential was stepped from 0.0 to 0.4 V. (b) Mean particle diameter vs. deposition time (as taken from SEM analysis). (c) Particle density vs. deposition time.



Fig. 5 (a) SEM images and corresponding histogram analysis showing the particle size distribution of the AgNPs deposited at a CVD-Gr elec-trodes at 0.2, 0.4 V, 0.6 V and 0.8 V for 30 s, from a solution containing 0.7 mM AgNO<sub>3</sub> in 0.2 M KNO<sub>3</sub>. (b) Mean particle diameter vs. applied potential (as taken from SEM analysis). (c) Particle density vs. applied potential.

#### Electrodeposition of palladium NPs

The effectiveness of CVD-Gr as an electrode for the electrodeposition of metal NPs was further tested with the decoration of CVD-Gr with palladium NPs (PdNPs). According to the CV (ESI9<sup>†</sup>) obtained from a solution containing 0.5 mM Pd(NO<sub>3</sub>)<sub>2</sub> in 0.2 M KNO<sub>3</sub>, the reduction of Pd<sup>2+</sup> to Pd<sup>0</sup> takes place irreversibly at a potential below 0.2 V (vs. Ag/AgCl), so for this experiment the potential was stepped from 0.0 V to 0.4 V for 30 s, in order to compare the results with those obtained for the electrodeposition of AgNPs under the same conditions. Note that the standard redox couple for the pair  $Pd^{2+}/Pd^{0}$  is 0.987 V, and thus an electroless deposition process due to the presence of copper is also expected when applying a voltage below the



Fig. 6 SEM analysis of electrodeposition of PdNPs at a CVD-Gr electrode obtained by stepping the voltage 0.0 V to 0.4 V for 30 s, in a solution containing 0.5 mM Pd(NO3)2 in 0.2 M KNO3.

"electroless suppression voltage" (i.e. 0.647 V vs. Ag/AgCl for Pd). Unfortunately, the occurrence of the electroless process hampers a proper comparison between the current–time curves obtained from the electrodeposition/electroless process of Ag and Pd NPs. However, a dominant factor in the metal nucle-ation rate will be the kinetics of the electron transfer. As already shown, the reduction of Ag<sup>+</sup> to Ag<sup>0</sup> is a fast one-electron process. According to previous reports, the reduction of Pd<sup>2+</sup> to Pd<sup>0</sup>, being a two-electron process, usually shows slower kinetics.<sup>6</sup> Therefore, in principle we might expect a slower particle nucleation for PdNPs compared with AgNPs.

Fig. 6 and ESI10<sup>+</sup> show typical SEM images of electro-deposited PdNPs on CVD-Gr. As with silver electrodeposition, small (<50 nm) PdNPs decorate the whole surface of the Gr electrode along with a smaller number of larger (100 nm) particles which by comparison with the silver electrodeposition we can attribute to the electroless process. The size of the electrodeposited PdNPs were analysed and compared with the AgNPs obtained by applying equivalent conditions. As shown in Fig. 5 and 6, both systems showed a high particle density which suggest a rapid nucleation and growth of NPs, and further supports the strong electroactivity of the basal-plane of gra-phene. Moreover, under the same experimental conditions the size of the NPs is considerably smaller for the electrodeposited PdNPs (ca. 14.6 6.7 nm) than for the AgNPs (ca. 41.0 16.5 nm), in good agreement with previous reports.<sup>6</sup> Finally, the chemical nature of the samples was con rmed by X-ray photo-electron spectroscopy (XPS; ESI11<sup>+</sup>) which clearly shows the presence of either silver or palladium, as expected.

# Conclusion

In conclusion, we have proven that electrodeposition can be used to controllably deposit noble metal nanoparticles on gra-phene. By using chemical vapour deposition grown graphene directly on the copper growth substrate, we are able to study the electrodeposition process without the need to transfer (and contaminate) the graphene. We identify and isolate the elec-troless deposition process due to the underlying copper, as well as the intended electrodeposition process. The electroless process does not affect the electrodeposition process and can be completely suppressed for Ag by employing appropriate condi-tions. Using direct electrodeposition, it was possible to control the particle size and particle density on graphene via the applied potential and electrodeposition time. Interestingly, the homogeneous distribution of NPs across all the exposed Gr suggests that here both basal-plane and edge-plane of graphene are electrochemically active.

The trends observed here for the electrodeposition of NPs on graphene are similar to those shown by carbon nanotubes or HOPG,<sup>5,9,19,20,55</sup> where electrodeposition of metal NPs is typically characterized by a rapid nucleation of NPs (kinetical control) followed by a gradual growth (diffusion control). As a result, well dispersed NPs of narrow polydispersity are obtained. Although we have shown only simple single step electrodeposition processes for Ag and Pd here, these have shown behaviour consistent with prior work on HOPG and carbon nanotubes. As a result, our work demonstrates that the signi cant prior liter-ature on nanostructure electrodeposition on these surfaces can be directly translated to create functional nanostructures on graphene. Thus, it could be expected that this procedure could also be exploited for the electrodeposition of other noble metal nanoparticles or materials, including semiconductors or con-ducting polymers. Hence, the electrochemical modi cation of graphene offers an easy and versatile approach for tailoring functionality for a variety of applications such as catalysis, sensing or biomedical applications.<sup>1-3,58</sup>

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# Notes and references

- 1 L. Dykman and N. Khlebtsov, Chem. Soc. Rev., 2012, 41, 2256.
- 2 A. Bonanni, M. Pumera and Y. Miyahara, Phys. Chem. Chem. Phys., 2011, **13**, 4980.
- 3 N. Goubet, I. Tempra, J. Yang, G. Soavi, D. Polli, G. Cerullo and M. P. Pileni, Nanoscale, 2015, 7, 3237.
- 4 P. Munnik, P. E. de Jongh and K. P. de Jong, Chem. Rev., 2015, 115, 6687.
- 5 T. M. Day, P. R. Unwin and J. V. Macpherson, Nano Lett., 2007, 7, 51.
- 6 T. M. Day, P. R. Unwin, N. R. Wilson and J. V. Macpherson, J. Am. Chem. Soc., 2005, 127, 10639.
- 7 R. M. Penner, J. Phys. Chem. B, 2002, 106, 3339.
- 8 F. Favier, E. C. Walter, M. P. Zach, T. Benter and R. M. Penner, Science, 2001, 293, 2227.
- 9 J. V. Zoval, J. Lee, S. Gorer and R. M. Penner, J. Phys. Chem. B, 1998, 5647, 1166.
- 10 K. T. Nguyen and Y. Zhao, Nanoscale, 2014, 6, 6245.
- 11 C. Bosch-Navarro, Z. P. L. Laker, H. R. Thomas, A. J. Marsden, J. Sloan, N. R. Wilson and J. P. Rourke, Angew. Chem., Int. Ed., 2015, 54, 9560.
- 12 C. Bosch-Navarro, E. Coronado and C. Mart´ı-Gastaldo, Carbon, 2013, 54, 201.
- 13 P. Pandey, G. R. Bell, J. P. Rourke, A. M. Sanchez, M. D. Elkin, B. J. Hickey and N. R. Wilson, Small, 2011, 7, 3202.

- 14 G. Goncalves, P. a. a. P. Marques, C. M. Granadeiro, H. I. S. Nogueira, M. K. Singh and J. Gr´acio, Chem. Mater., 2009, 21, 4796.
- 15 M. Giovanni, H. L. Poh, A. Ambrosi, G. Zhao, Z. Sofer, F. Sanek, B. Khezri, R. D. Webster and M. Pumera, Nanoscale, 2012, 4, 5002.
- 16 R. J. Toh, H. L. Poh, Z. Sofer and M. Pumera, Chem.–Asian J., 2013, 8, 1295.
- 17 C. N. R. Rao, a. K. Sood, K. S. Subrahmanyam and A. Govindaraj, Angew. Chem., Int. Ed., 2009, 48, 7752.
- 18 J. L. Delgado, M. Herranz and N. Mart´ın, J. Mater. Chem., 2008, 18, 1417.
- 19 H. Liu, F. Favier, K. Ng, M. P. Zach and R. M. Penner, Electrochim. Acta, 2001, 47, 671.
- 20 T. M. Day, P. R. Unwin, N. R. Wilson and J. V. Macpherson, J. Am. Chem. Soc., 2005, 127, 10639.
- 21 P. V. Dudin, M. E. Snowden, J. V. MacPherson and P. R. Unwin, ACS Nano, 2011, 5, 10017.
- 22 P. V. Dudin, P. R. Unwin and J. V. Macpherson, J. Phys. Chem. C, 2010, 114, 13241.
- 23 Y. Zhu, S. Murali, W. Cai, X. Li, J. W. Suk, J. R. Potts and R. S. Ruoff, Adv. Mater., 2010, 22, 3906.
- 24 Y. Zhang, L. Zhang and C. Zhou, Acc. Chem. Res., 2013, 46, 2329.
- 25 D. Chen, H. Feng and J. Li, Chem. Rev., 2012, 112, 6027.
- 26 C. Bosch-Navarro, E. Coronado, C. Marti-Gastaldo, J. F. Sanchez-Royo and M. G. Gomez, Nanoscale, 2012, 4, 3977.
- 27 H. R. Thomas, S. P. Day, W. E. Woodru, C. Valle, R. J. Young, I. A. Kinloch, G. W. Morley, J. V. Hanna, N. R. Wilson and J. P. Rourke, Chem. Mater., 2013, 25, 3580.
- 28 J. P. Rourke, P. Pandey, J. J. Moore, M. Bates, I. Kinloch, R. J. Young and N. R. Wilson, Angew. Chem., Int. Ed. Engl., 2011, 50, 3173.
- 29 N. Petrone, C. R. Dean, I. Meric, A. M. Van Der Zande, P. Y. Huang, L. Wang, D. Muller, K. L. Shepard and J. Hone, Nano Lett., 2012, 12, 2751.
- 30 S. Park and R. S. Ruoff, Nat. Nanotechnol., 2009, 4, 217.
- 31 R. S. Sundaram, C. G´omez-Navarro, K. Balasubramanian, M. Burghard and K. Kern, Adv. Mater., 2008, 20, 3050.
- 32 A. Gut´es, B. Hsia, A. Sussman, W. Mickelson, A. Zettl, C. Carraro and R. Maboudian, Nanoscale, 2012, 4, 438.
- 33 Z. Li, P. Zhang, K. Wang, Z. Xu, J. Wei, L. Fan, D. Wu and H. Zhu, J. Mater. Chem., 2011, 21, 13241.
- 34 M. Pumera, Electrochem. Commun., 2013, 36, 14.
- 35 W. Li, C. Tan, M. A. Lowe, H. D. Abruna and D. C. Ralph, ACS Nano, 2011, 5, 2264.

- 36 D. a. C. Brownson, S. a. Varey, F. Hussain, S. J. Haigh and C. E. Banks, Nanoscale, 2014, 6, 1607.
- 37 J. Zhong, J. Zhang, X. Jin, J. Liu, Q. Li, M. Li, W. Cai, D. Wu, D. Zhan and B. Ren, J. Am. Chem. Soc., 2014, 136, 16609.
- 38 J. Zhong, J. Liu, Q. Li, M.-G. Li, Z.-C. Zeng, S. Hu, D. Wu, W. Cai and B. Ren, Electrochim. Acta, 2013, 110, 754.
- 39 N. L. Ritzert, J. Rodr'iguez-L'opez, C. Tan and H. D. Abruna, Langmuir, 2013, 29, 1683.
- 40 H. V. Patten, M. Velicky, N. Clark, C. A. Muryn, I. A. Kinloch and R. A. W. Dryfe, Faraday Discuss., 2014, 172, 26.
- 41 J. W. Suk, W. H. Lee, J. Lee, H. Chou, R. D. Piner, Y. Hao,D. Akinwande and R. S. Ruoff, Nano Lett., 2013, 13, 1462.
- 42 A. Ambrosi and M. Pumera, J. Phys. Chem. C, 2013, 117, 2053.
- 43 C. J. Shih, Q. H. Wang, S. Lin, K. C. Park, Z. Jin, M. S. Strano and D. Blankschtein, Phys. Rev. Lett., 2012, 109, 1.
- 44 A. Ambrosi and M. Pumera, Nanoscale, 2014, 6, 472.
- 45 C. Tan, J. Rodr´ıguez-L´opez, J. J. Parks, N. L. Ritzert, D. C. Ralph and H. D. Abruna, ACS Nano, 2012, 6, 3070.
- 46 M. Velicky, D. F. Bradley, A. J. Cooper, E. W. Hill, I. A. Kinloch, A. Mishchenko, K. S. Novoselov, H. V Patten, P. S. Toth, A. T. Valota, S. D. Worrall and R. A. W. Dryfe, ACS Nano, 2014, 8, 10089.
- 47 C. Bosch-Navarro, Z. P. L. Laker, J. P. Rourke and N. R. Wilson, Phys. Chem. Chem. Phys., 2015, 17, 29628.
- 48 N. R. Wilson, A. J. Marsden, M. Saghir, C. J. Bromley,
  R. Schaub, G. Costantini, T. W. White, C. Partridge,
  A. Barinov, P. Dudin, A. M. Sanchez, J. J. Mudd, M. Walker and
  G. R. Bell, Nano Res., 2013, 6, 99.
- 49 V. Miseikis, D. Convertino, N. Mishra, M. Gemmi, T. Mashoff, S. Heun, N. Haghighian, F. Bisio, M. Canepa, V. Piazza and C. Coletti, 2D Mater., 2015, 2, 014006.
- 50 C. A. Schneider, W. S. Rasband and K. W. Eliceiri, Nat. Methods, 2012, 9, 671.
- 51 A. C. Ferrari, Solid State Commun., 2007, 143, 47.
- 52 L. Qu and L. Dai, J. Am. Chem. Soc., 2005, 127, 10806.
- 53 X. W. Liu, J. J. Mao, P. De Liu and X. W. Wei, Carbon, 2011, 49, 477.
- 54 A. Gut'es, C. Carraro and R. Maboudian, Biosens. Bioelectron., 2012, 33, 56.
- 55 J. Zoval, R. Stinger, P. Biernacki and R. Penner, J. Phys. Chem., 1996, 100, 837.
- 56 S. C. S. Lai, R. A. Lazenby, P. M. Kirkman and P. R. Unwin, Chem. Sci., 2014, 6, 1126.
- 57 W. Yuan, Y. Zhou, Y. Li, C. Li, H. Peng, J. Zhang, Z. Liu, L. Dai and G. Shi, Sci. Rep., 2013, 3, 1.
- 58 X. Zhou, M. Dorn, J. Vogt, D. Spemann, W. Yu, Z. Mao, I. Estrela-Lopis, E. Donath and C. Gao, Nanoscale, 2014, 6, 8535.